Nucleation Control in Physical Vapor Transport Growth of AlN Single Crystals on Polycrystal Tungsten Substrates

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The improved resistively-heated furnace with two heaters established a vertical thermal gradient to control nucleation during AlN single crystals Physical Vapor Transport (PVT) growth on polycrystal tungsten substrates. During the high temperature (> 1850 °C) heating process, the reverse temperature field (i.e., the temperature difference between the sublimation zone and the crystalline zone ΔT<0) was obtained to reduce the number of nuclei on the tungsten substrate. During growth, the proper positive values of ΔT were chosen to content the supersaturation values (0.25 < S < 0.3). The reverse temperature condition during high temperature (> 1850 °C) cooling was fulfilled to avoid recrystallization on grown AlN crystal. AlN single crystals made through the method were characterized by X-ray diffractions (XRD) and Raman spectroscopy.

Keywords: growth from vapour, single-crystal growth, nitrides, X-ray diffraction.

1. INTRODUCTION

Aluminium nitride (AlN) crystal is a typical representative of the third generation semiconductor materials. It possesses excellent electrical and optical properties such as high breakdown field strength, high thermal conductivity, and high carrier saturation velocity etc. Furthermore, AlN has an extra wide direct bandgap (6.2 eV). AlN presents great potential for the application in deep-ultraviolet (DUV) optoelectronic devices such as light emitting diodes (LEDs), laser diodes (LDs) and photodetectors. Thus, AlN has attracted increasing attentions in the field of electronics and optoelectronics. In 2006, Taniyasu et al fabricated successfully AlN-based LEDs, which had a short wavelength about 210 nanometers [1, 2]. AlN crystal can change from solid to liquid at high temperature (~ 3000 K) and high vapor pressure (~ 200 atm), so it is rarely fabricated from melt. Over the past several decades, it is proved that the physical vapor transport (PVT) is the most widely used and promising method of large-size single crystal AlN [3–7]. Different research groups studying AlN crystal growth have developed PVT process technologies. As of the publication date, a single AlN crystal of 1 inch in diameter has been grown by PVT [5–7]. The growth temperature for AlN crystals is so high that tungsten has been identified as an appropriate material for crucibles and substrate in which to grow AlN crystals. But the tungsten substrates are usually polycrystals. Usually, the sublimation temperature is higher than the crystallization temperature at the heating-up stage, which means ΔT>0 (where ΔT is the temperature difference between sublimation zone and crystallization zone). There are high-density AlN nucleation points on polycrystal tungsten substrates. Usually, we can only obtain polycrystalline AlN boules (e.g., AlN shown as Fig. 1 a).

In this study, the improved resistively-heated furnace will provide a vertical thermal gradient to reduce the number of nuclei on the substrate. At the heating-up stage, the value of ΔT is less than zero at the heating-up stage, which is called the condition of the reverse temperature field. During growth, the positive temperature gradient (ΔT>0) is established and close to thermal equilibrium growth conditions. Finally, we grow only a few detached AlN single crystals on the polycrystalline tungsten substrate.

2. EXPERIMENTAL METHODS

In general, PVT crystal-growth processes are performed in a graphite or tungsten heating element furnace with a resistive or inductive heating system, as in the case of SiC crystal growth by PVT. Due to its success in SiC crystal growth, the induction heating furnace has also been chosen for AlN growth [8, 9]. In spite of the advantages of fast heating and energy savings, the induction heating furnace has the problems of carbon doping as well as the precise control of the temperature. In a purity nitrogen environment (99.999 %) at 0.8 – 1.2 atm, the growth experiments were performed in a improved resistance-heated furnace. The growth unit (Fig. 2 c) has two heaters (main/top) and their respective infrared two-color thermometers for temperature measurement. By adjusting the heaters which provide the sublimation zone and the crystalline zone with heat respectively, we can control the vertical temperature gradient accurately. And a tungsten crucible is employed to grow crystals. AlN polycrystals are used as the source and resublimated to achieve the high-purify AlN before growth. With this two-
heater configuration, AlN can be fabricated on the nucleation zone, where conditions approach thermal equilibrium, producing bulk single crystals.

With an X-ray Diffraction (XRD) with Cu Kα radiation on a Philips X-ray diffractometer at 40 kV and 40 mA, the crystal orientation and crystallinity of the samples were evaluated. Raman measurements were also employed via a Renishaw Raman spectrometer (inVia Reflex) with spectral resolution of 1.5 cm⁻¹, where a 532 nm laser (Samba CW DPSS) with a power of 3 mW for exciting light was used.

3. RESULTS AND DISCUSSION

The relevant curves obtained by experimental and calculated results, which mainly relate to growth temperature (> 1850 °C) and vapor pressure (0.8 – 1.2 atm) have described well the sublimation performance of AlN [3, 10]. The equation AlN(s) ↔ Al(g) + ½N₂(g) can indicate the process of AlN’s sublimation-recondensation. Actually, there are five sub-procedures during AlN growth by PVT: a – sublimation of the source; b – mass transfer of the vapor species; c – adsorption on the substrate surface; d – diffusion and nucleation on the substrate surface, and e – desorption [8]. We need low nucleation densities to grow high-quality bulk AlN crystal and a speed high enough for commercial production. The parameters can be optimized by simulations about the temperature field and supersaturation. In thermal equilibrium, the local supersaturation can be described by [11]

\[ S = \frac{p_{Al}^2 \cdot p_{N2}}{K(T)} - 1, \]  

where \( p_{Al} \) is the pressure of Al vapor, \( p_{N2} \) is the pressure of \( N_2 \), and \( K(T) \) is the equilibrium constant. Al vapour pressure \( (p_{Al}) \) increases with temperature. When the ambient pressure \( (p_{N2}) \) is fixed in a given growth setup, alterable technological parameters are growth temperature \( T \) and \( \Delta T \). Excessive low supersaturation results in too low growth rates. On the contrary, exorbitant supersaturation leads to defective densities and high-density nucleation points that fabricate polycrystalline AlN. Many experiments with different \( T \) and \( \Delta T \) were carried out to investigate the adequate supersaturation range [7, 8, 11]. It has been proven that detached freestanding high-quality AlN single crystals with large size can be obtained when the values of supersaturation are between 0.25 and 0.3 [8]. The appropriate temperature for the AlN source and the nucleation zone ranges from 2050 °C to 2350 °C [5 – 7] which supplies sufficient surface mobility and mass transport for growth rates greater than or equal to 100 μm/h. Due to the high vapor pressures of Al and \( N_2 \) at these temperatures, the temperature gradients must be maintained at 5 – 20 °C/cm. The absence of the seeds makes researchers fabricate AlN polycrystals by spontaneous crystallization on planar W (or TaC) lids. In general, the AlN polycrystals are formed on the planar lid. To solve this problem, Slack et al designed a conical zone as the nucleation region in a tungsten crucible, shown in Fig. 2 a. The tip of the conical crucible allows a single crystal to grow in a dominant position [12]. But each crucible can only be used once and AlN single crystals above 1 inch in diameter can rarely be grown. Hartmann et al use the method of spontaneous nucleation and subsequent freestanding growth [6]. The growth setup (shown as Fig. 2 b), where a perforated sheet inside the crucible above the source material acts as a nucleation area, has been improved to promote spontaneous nucleation of large, high-quality AlN seeds. In this configuration, AlN can be grown on both the nucleation area, where conditions approach thermal equilibrium, and on the top of the tungsten crucible, typically as polycrystals. Now, this method only yields AlN single crystals about 10 mm in diameter.

![Fig. 1. Temperature variation trends of the crucible and the substrate during the growth process of AlN (i.e., from stage (i) to stage (vi)). The black line with dash dots represents the temperature of the crystallization zone and the blue line represents the temperature of the sublimation zone. The inset a shows AlN crystals on the polycrystal tungsten substrates: a – traditional growth model; b – a reverse temperature field method](image-url)
A multiple physical finite elements to analyze software (COMSOL Multiphysics) is employed to investigate the temperature field of growth chamber. A 2D axisymmetric stationary model is created to simulate the crucible temperature field in a nitrogen environment at 1 atm. The initial temperature is set to 25 °C and the constant temperature of furnace walls with 25 °C is set as boundary conditions. From Fig. 3, it can be seen that the temperature distribution is basically consistent with the previous analysis.

It is necessary to note that the lowest temperature appears at the bottom of the crucible. This is unfavorable to the later growth of the crystal and the growth device may also need to be further optimized. A reverse temperature field on the stage (v) is still chosen to help avoid recrystallize during cooling because of high temperature above 1850 °C. These results show that a reverse temperature field method can control AlN nucleation and is a promising PVT growth method for large-size single crystal of AlN on polycrystalline tungsten substrates. Now, a AlN single crystal with a diameter up to 2.2 centi-meters has been fabricated with optimizing experimental parameters [7].

The ω/2θ-scans have been measured over a range of around 40 to estimate the orientation of the AlN crystal. The inset of Fig. 4 shows a ω/2θ XRD data of this sample, in which there is only a strong diffraction peak at 36.04° corresponds to the (0002) lattice plane, indicating the C-plane AlN single crystal.

Fig. 4 shows the Raman spectrum of the AlN under 1 atm pressure and room temperature. Raman-active optical phonon modes of $A_1$(TO), $E_2$(TO), $E_1$(TO) and $E_1$(LO) can be clearly observed from the Raman spectrum. The peak
positions of the four modes are centered at 620.1 cm\(^{-1}\), 656.8 cm\(^{-1}\), 669.3 cm\(^{-1}\), and 913.1 cm\(^{-1}\), respectively, which agree well with other reports [13, 14]. The full-width at half maximum (FWHM) of \(E_2\) mode is less than 8.6 cm\(^{-1}\), indicating that the AlN crystal quality is high.

4. CONCLUSIONS

In this manuscript, the improved resistively-heated furnace is employed to nucleation control in PVT growth of AlN single crystals on polycrystalline tungsten substrates. The growth unit includes two heaters for a vertical temperature gradient between the sublimation zone and the crystalline zone. The reverse temperature field (i.e., \(\Delta T < 0\)) during high temperature (> 1850 °C) heating and high temperature cooling, can help avoid nucleation on the substrate and recrystallize on AlN crystal, respectively. During the growth stage, \(\Delta T\) are chose to the proper positive values, which make growth conditions approach thermal equilibrium states. Finally, only several separated AlN single crystals have been prepared.

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